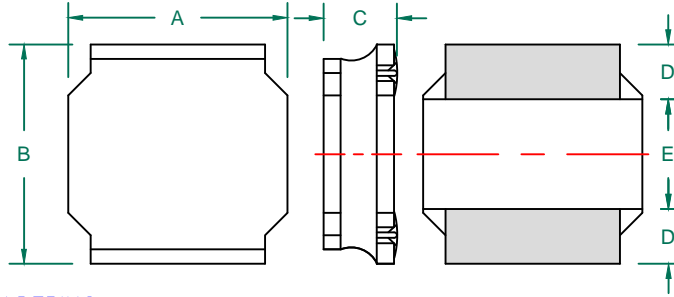


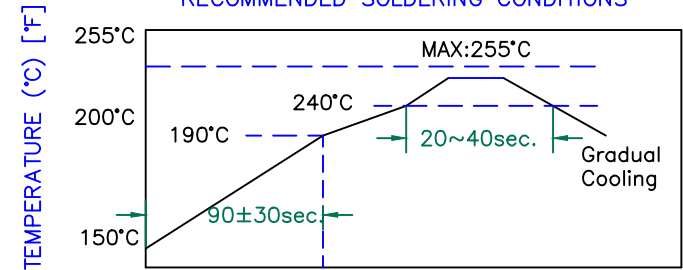
TYS30152R2N-10

PHYSICAL DIMENSIONS:

A	3.00	±	0.20
B	3.00	±	0.20
C	1.50	+ -	0.20 0.30
D	1.10	±	0.30
E	0.80	±	0.30



RECOMMENDED SOLDERING CONDITIONS

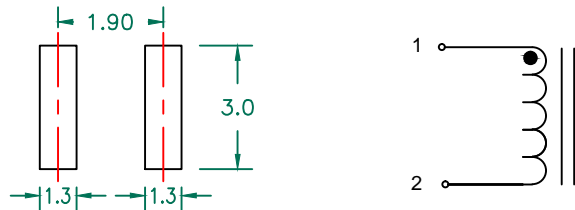


ELECTRICAL SPECIFICATION

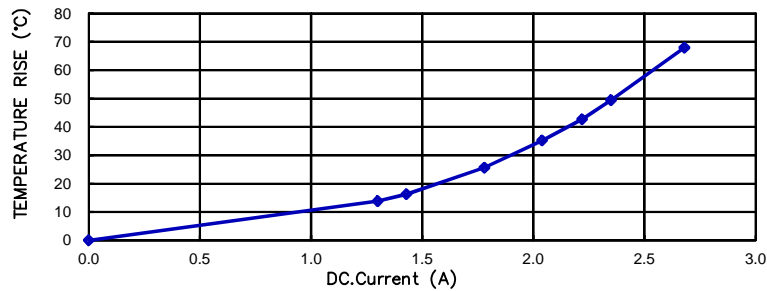
	Min	Nom	Max
INDUCTANCE (uH) L @ 100 KHz/1V ± 30%	1.54	2.20	2.86
DCR (Ω)		0.060	0.078

Saturation Current(A)	1.60
SRF (MHz)	86
Temperature Rise Current (A)	1.60

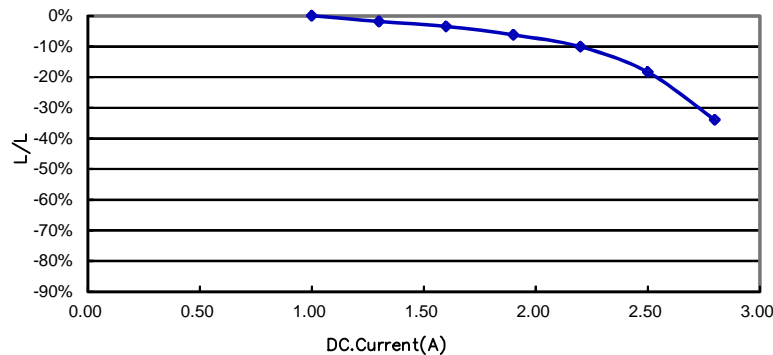
LAND PATTERNS FOR REFLOW SOLDERING



CHARACTERISTICS OF TEMPERATURE RISE



CURRENT VS INDUCTANCE DROP IN RATES



RoHS

NOTES:

- OPERATION TEMPERATURE RANGE: -40°C~+125°C (INCLUDING SELF-HEATING).
- STORAGE TEMPERATURE RANGE (PACKAGING CONDITIONS): -10°C TO +40°C AND RH 70% (MAX.)
- UNLESS OTHERWISE SPECIFIED, THE STANDARD ATMOSPHERIC CONDITIONS FOR MEASUREMENT/TEST AS:
A. AMBIENT TEMPERATURE: 20±15°C.
B. RELATIVE HUMIDITY: 65%±20%.
- SATURATION CURRENT IS THE DC CURRENT AT WHICH THE INDUCTANCE DROPS OFF APPROXIMATELY 30% FROM ITS VALUE WITHOUT CURRENT.(AMBIENT TEMPERATURE 25±5°C)
- TEMPERATURE RISE CURRENT (IRMS):
DC CURRENT THAT CAUSES THE TEMPERATURE RISE (ΔT ≤40°C) FROM 25°C AMBIENT.

DIMENSIONS ARE IN mm .				This print is the property of Laird Tech. and is loaned in confidence subject to return upon request and with the understanding that no copies shall be made without the written consent of Laird Tech. All rights to design or invention are reserved.			
				Laird			
PROJECT/PART NUMBER:				REV	PART TYPE:	DRAWN BY:	
TYS30152R2N-10				C	POWER INDUCTOR	QIU	
C	CHANGE DIMENSIONS: C/D/E	07/28/16	QIU	DATE:	08/07/12	SCALE:	NTS
B	CHANGE LOGO	07/28/15	QIU	CAD #		TOOL #	
A	ORIGINAL DRAFT	08/07/12	QIU	TYS30152R2N-10-C			
REV	DESCRIPTION	DATE	INT				1 of 1